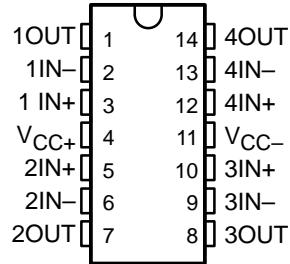


LM148, LM248, LM348 QUADRUPLE OPERATIONAL AMPLIFIERS

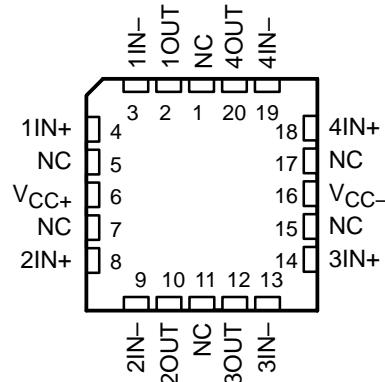
SLOS058C – OCTOBER 1979 – REVISED DECEMBER 2002

- **μ A741 Operating Characteristics**
- **Low Supply-Current Drain . . . 0.6 mA Typ (per amplifier)**
- **Low Input Offset Voltage**
- **Low Input Offset Current**
- **Class AB Output Stage**
- **Input/Output Overload Protection**
- **Designed to Be Interchangeable With Industry Standard LM148, LM248, and LM348**

LM148 . . . J PACKAGE
LM248 . . . D OR N PACKAGE
LM348 . . . D, N, OR NS PACKAGE
(TOP VIEW)



LM148 . . . FK PACKAGE
(TOP VIEW)



NC – No internal connection

ORDERING INFORMATION

T_A	V_{IOMAX} AT 25°C	PACKAGE†		ORDERABLE PART NUMBER	TOP-SIDE MARKING
0°C to 70°C	6 mV	PDIP (N)	Tube of 25	LM348N	LM348N
		SOIC (D)	Tube of 50	LM348D	LM348
			Reel of 2500	LM348DR	
-25°C to 85°C	6 mV	SOP (NS)	Reel of 2000	LM348NSR	LM348
		PDIP (N)	Tube of 25	LM248N	LM248
		SOIC (D)	Tube of 50	LM248D	
-55°C to 125°C	5 mV		Reel of 2500	LM248DR	
		CDIP (J)	Tube of 25	LM148J	LM148
		LCCC (FK)	Tube of 50	LM148FK	

† Package drawings, standard packing quantities, thermal data, symbolization, and PCB design guidelines are available at www.ti.com/sc/package.



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PRODUCTION DATA information is current as of publication date. Products conform to specifications per the terms of Texas Instruments standard warranty. Production processing does not necessarily include testing of all parameters.



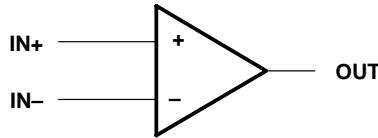
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On products compliant to MIL-PRF-38535, all parameters are tested unless otherwise noted. On all other products, production processing does not necessarily include testing of all parameters.

LM148, LM248, LM348 QUADRUPLE OPERATIONAL AMPLIFIERS

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symbol (each amplifier)



absolute maximum ratings over operating free-air temperature range (unless otherwise noted)[†]

Supply voltage, V_{CC+} (see Note 1):	LM148	22 V
	LM248, LM348	18 V
Supply voltage, V_{CC-} (see Note 1):	LM148	-22 V
	LM248, LM348	-18 V
Differential input voltage, V_{ID} (see Note 2):	LM148	44 V
	LM248, LM348	36 V
Input voltage, V_I (either input, see Notes 1 and 3):	LM148	-22 V
	LM248, LM348	-18 V
Duration of output short circuit (see Note 4)		Unlimited
Operating virtual junction temperature, T_J		150°C
Package thermal impedance, θ_{JA} (see Notes 5 and 6):	D package	86°C/W
	N package	80°C/W
	NS package	76°C/W
Package thermal impedance, θ_{JC} (see Notes 7 and 8):	FK package	5.61°C/W
	J package	15.05°C/W
Case temperature for 60 seconds: FK package		260°C
Lead temperature 1.6 mm (1/16 inch) from case for 10 seconds: J package		300°C
Lead temperature 1.6 mm (1/16 inch) from case for 60 seconds: D, N, or NS package		260°C
Storage temperature range, T_{stg}		-65°C to 150°C

[†] Stresses beyond those listed under "absolute maximum ratings" may cause permanent damage to the device. These are stress ratings only, and functional operation of the device at these or any other conditions beyond those indicated under "recommended operating conditions" is not implied. Exposure to absolute-maximum-rated conditions for extended periods may affect device reliability.

NOTES: 1. All voltage values, unless otherwise noted, are with respect to the midpoint between V_{CC+} and V_{CC-} .

2. Differential voltages are at $IN+$ with respect to $IN-$.
3. The magnitude of the input voltage must never exceed the magnitude of the supply voltage or the value specified in the table, whichever is less.
4. The output may be shorted to ground or either power supply. Temperature and/or supply voltages must be limited to ensure that the dissipation rating is not exceeded.
5. Maximum power dissipation is a function of $T_J(max)$, θ_{JA} , and T_A . The maximum allowable power dissipation at any allowable ambient temperature is $P_D = (T_J(max) - T_A)/\theta_{JA}$. Operating at the absolute maximum T_J of 150°C can affect reliability.
6. The package thermal impedance is calculated in accordance with JESD 51-7.
7. Maximum power dissipation is a function of $T_J(max)$, θ_{JC} , and T_C . The maximum allowable power dissipation at any allowable ambient temperature is $P_D = (T_J(max) - T_C)/\theta_{JC}$. Operating at the absolute maximum T_J of 150°C can affect reliability.
8. The package thermal impedance is calculated in accordance with MIL-STD-883.

recommended operating conditions

	MIN	MAX	UNIT
Supply voltage, V_{CC+}	4	18	V
Supply voltage, V_{CC-}	-4	-18	V

electrical characteristics at specified free-air temperature, $V_{CC\pm} = \pm 15$ V (unless otherwise noted)

PARAMETER	TEST CONDITIONS [†]	LM148			LM248			LM348			UNIT
		MIN	TYP	MAX	MIN	TYP	MAX	MIN	TYP	MAX	
V_{IO} Input offset voltage	$V_O = 0$	25°C		1 5		1 6		1 6		1 6	mV
		Full range		6		7.5		7.5		7.5	
I_{IO} Input offset current	$V_O = 0$	25°C		4 25		4 50		4 50		4 50	nA
		Full range		75		125		100		100	
I_{IB} Input bias current	$V_O = 0$	25°C		30 100		30 200		30 200		30 200	nA
		Full range		325		500		400		400	
V_{ICR} Common-mode input voltage range		Full range		± 12		± 12		± 12		± 12	V
V_{OM} Maximum peak output voltage swing	$R_L = 10$ kΩ	25°C		± 12 ± 13		± 12 ± 13		± 12 ± 13		± 12 ± 13	V
	$R_L \geq 10$ kΩ	Full range		± 12		± 12		± 12		± 12	
	$R_L = 2$ kΩ	25°C		± 10 ± 12		± 10 ± 12		± 10 ± 12		± 10 ± 12	
	$R_L \geq 2$ kΩ	Full range		± 10		± 10		± 10		± 10	
A_{VD} Large-signal differential voltage amplification	$V_O = \pm 10$ V, $R_L = \geq 2$ kΩ	25°C	50	160	25	160	25	160	25	160	V/mV
		Full range	25		15		15		15		
r_i Input resistance [‡]		25°C	0.8	2.5	0.8	2.5	0.8	2.5	0.8	2.5	MΩ
B_1 Unity-gain bandwidth	$A_{VD} = 1$	25°C		1		1		1		1	MHz
ϕ_m Phase margin	$A_{VD} = 1$	25°C		60°		60°		60°		60°	
CMRR Common-mode rejection ratio	$V_{IC} = V_{ICR\min},$ $V_O = 0$	25°C	70	90	70	90	70	90	70	90	dB
		Full range	70		70		70		70		
k_{SVR} Supply-voltage rejection ratio ($\Delta V_{CC\pm}/\Delta V_{IO}$)	$V_{CC\pm} = \pm 9$ V to ± 15 V, $V_O = 0$	25°C	77	96	77	96	77	96	77	96	dB
		Full range	77		77		77		77		
I_{OS} Short-circuit output current		25°C		± 25		± 25		± 25		± 25	mA
I_{CC} Supply current (four amplifiers)	No load	$V_O = 0$	25°C			2.4 4.5		2.4 4.5		2.4 4.5	mA
		$V_O = V_{OM}$		2.4 3.6							
V_{O1}/V_{O2} Crosstalk attenuation	$f = 1$ Hz to 20 kHz	25°C		120		120		120		120	dB

[†] All characteristics are measured under open-loop conditions with zero common-mode input voltage, unless otherwise specified. Full range for T_A is -55°C to 125°C for LM148, -25°C to 85°C for LM248, and 0°C to 70°C for LM348.

[‡] This parameter is not production tested.

LM148, LM248, LM348 QUADRUPLE OPERATIONAL AMPLIFIERS

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operating characteristics, $V_{CC\pm} = \pm 15$ V, $T_A = 25^\circ\text{C}$

PARAMETER	TEST CONDITIONS	MIN	TYP	MAX	UNIT
SR Slew rate at unity gain	$R_L = 2 \text{ k}\Omega$, $C_L = 100 \text{ pF}$, See Figure 1		0.5		$\text{V}/\mu\text{s}$

PARAMETER MEASUREMENT INFORMATION

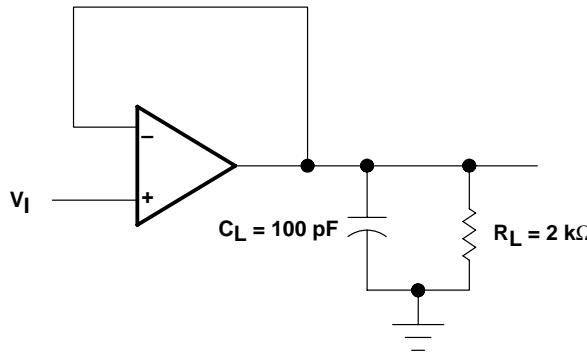


Figure 1. Unity-Gain Amplifier

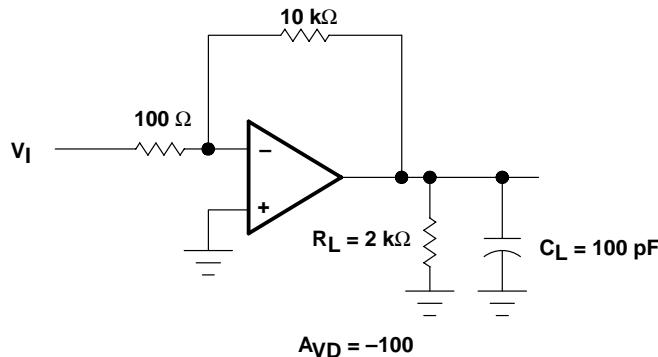
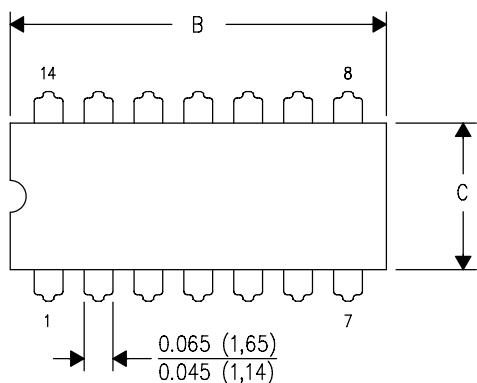


Figure 2. Inverting Amplifier

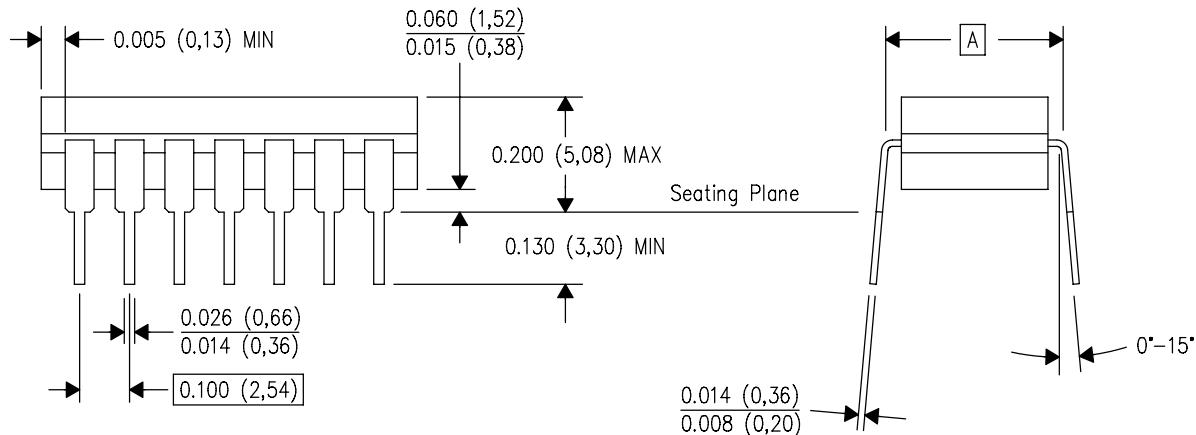
J (R-GDIP-T**)

14 LEADS SHOWN

CERAMIC DUAL IN-LINE PACKAGE



PINS **\nDIM	14	16	18	20
A	0.300 (7,62) BSC	0.300 (7,62) BSC	0.300 (7,62) BSC	0.300 (7,62) BSC
B MAX	0.785 (19,94)	.840 (21,34)	0.960 (24,38)	1.060 (26,92)
B MIN	—	—	—	—
C MAX	0.300 (7,62)	0.300 (7,62)	0.310 (7,87)	0.300 (7,62)
C MIN	0.245 (6,22)	0.245 (6,22)	0.220 (5,59)	0.245 (6,22)



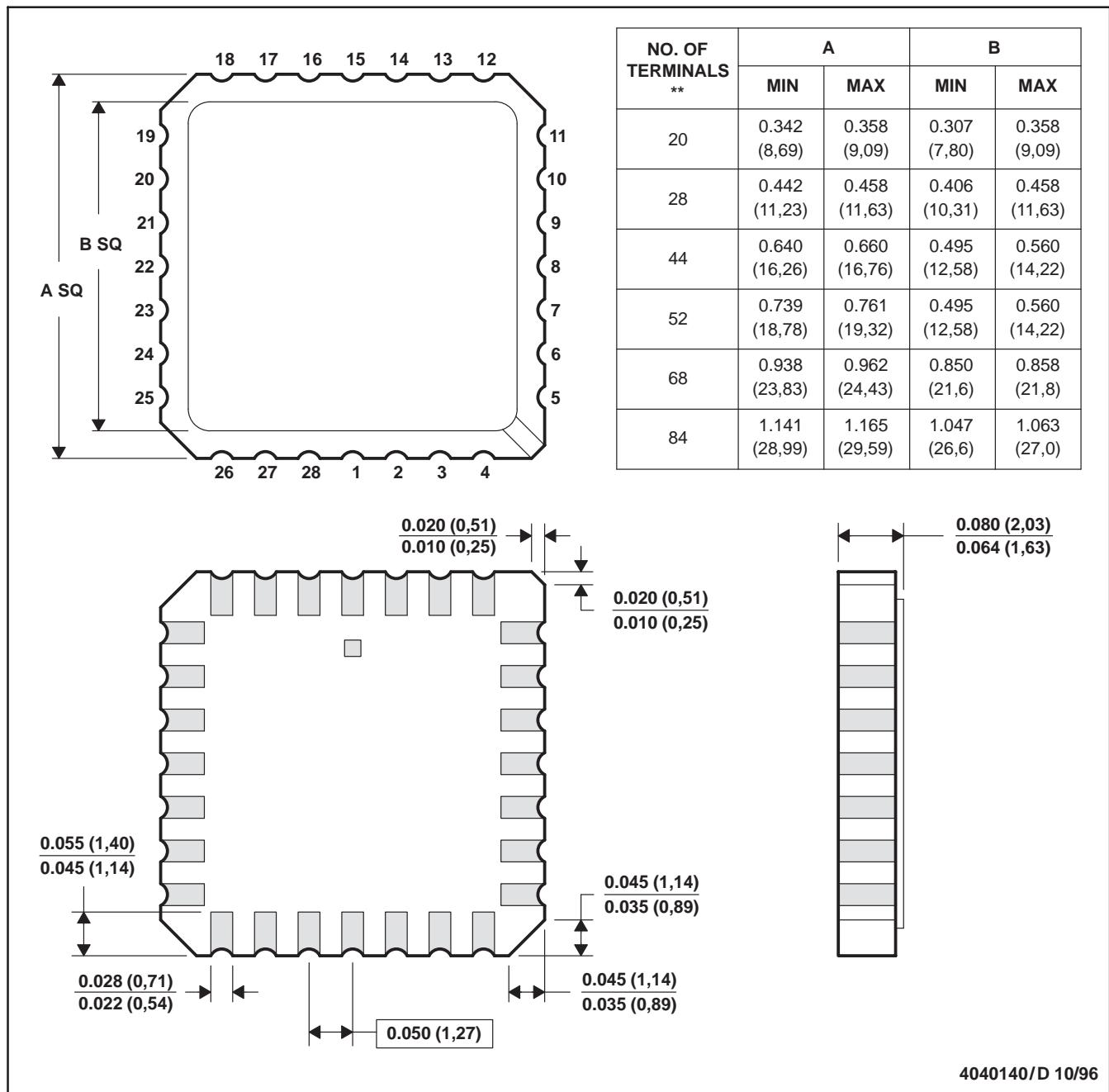
4040083/F 03/03

- NOTES:
- A. All linear dimensions are in inches (millimeters).
 - B. This drawing is subject to change without notice.
 - C. This package is hermetically sealed with a ceramic lid using glass frit.
 - D. Index point is provided on cap for terminal identification only on press ceramic glass frit seal only.
 - E. Falls within MIL STD 1835 GDIP1-T14, GDIP1-T16, GDIP1-T18 and GDIP1-T20.

FK (S-CQCC-N**)

LEADLESS CERAMIC CHIP CARRIER

28 TERMINAL SHOWN



NOTES: A. All linear dimensions are in inches (millimeters).

B. This drawing is subject to change without notice.

C. This package can be hermetically sealed with a metal lid.

D. The terminals are gold plated.

E. Falls within JEDEC MS-004

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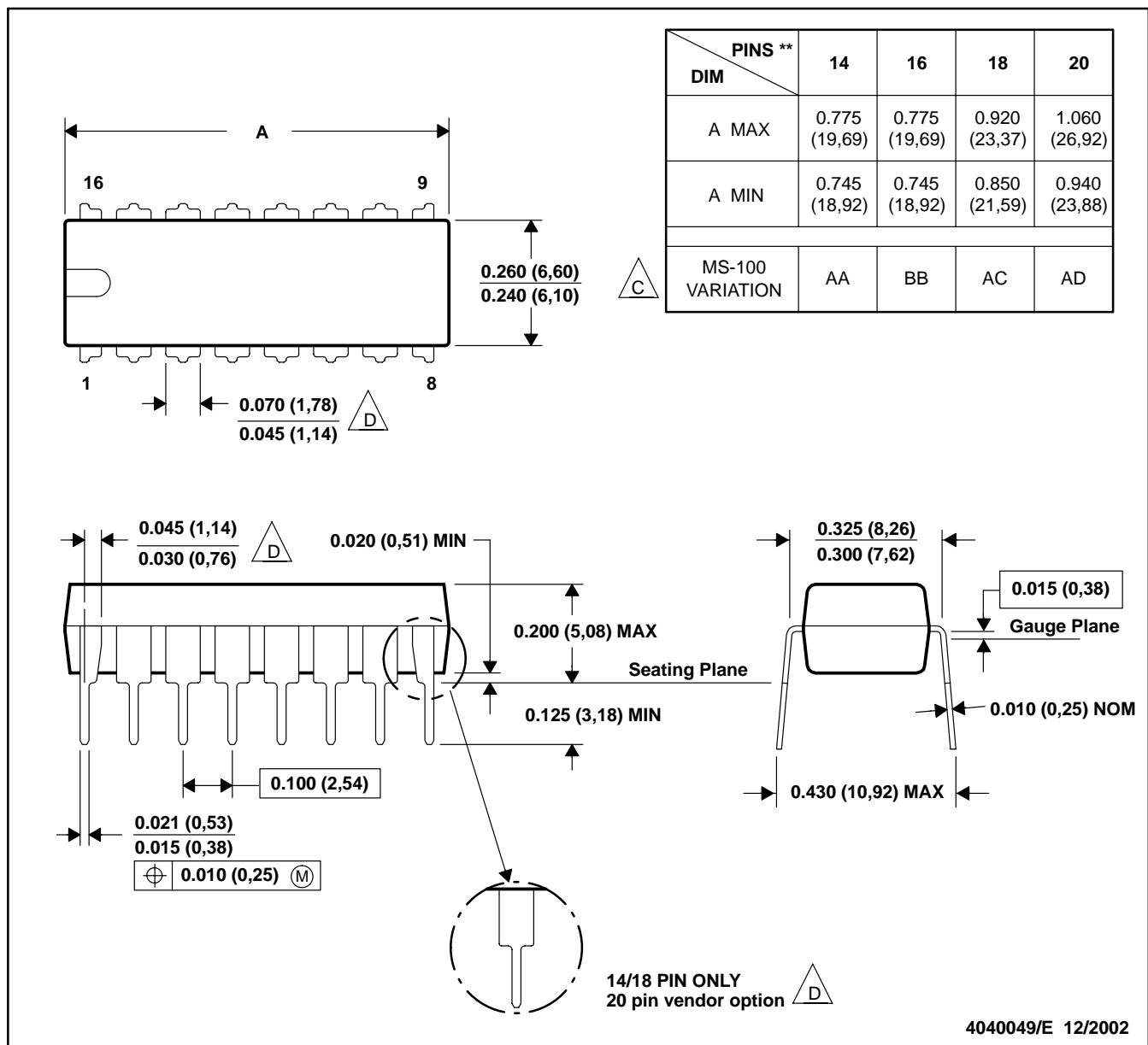
MECHANICAL

MPDI002C – JANUARY 1995 – REVISED DECEMBER 20002

N (R-PDIP-T**)

16 PINS SHOWN

PLASTIC DUAL-IN-LINE PACKAGE



NOTES: A. All linear dimensions are in inches (millimeters).

B. This drawing is subject to change without notice.

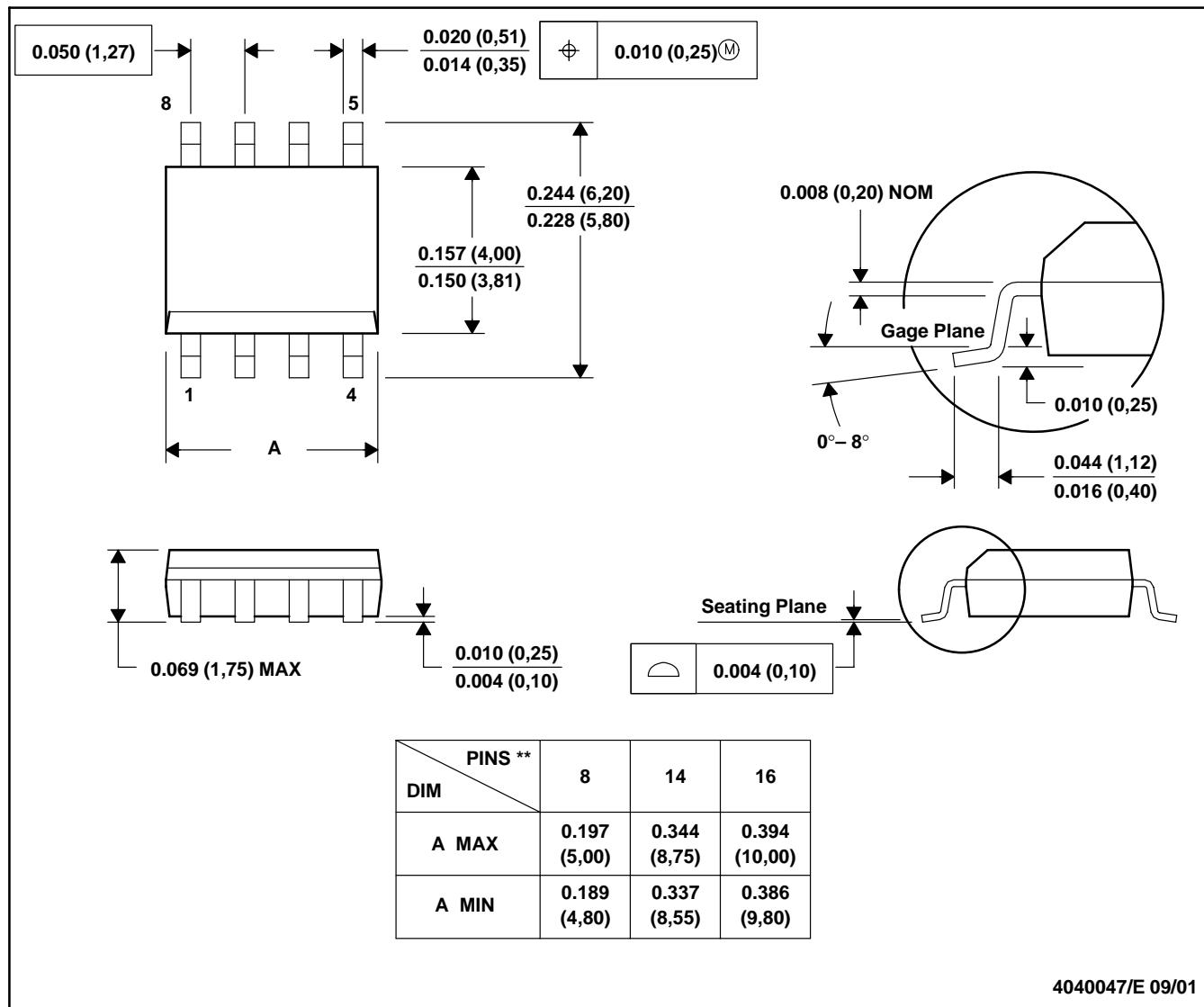
C. Falls within JEDEC MS-001, except 18 and 20 pin minimum body length (Dim A).

D. The 20 pin end lead shoulder width is a vendor option, either half or full width.

D (R-PDSO-G**)

PLASTIC SMALL-OUTLINE PACKAGE

8 PINS SHOWN



4040047/E 09/01

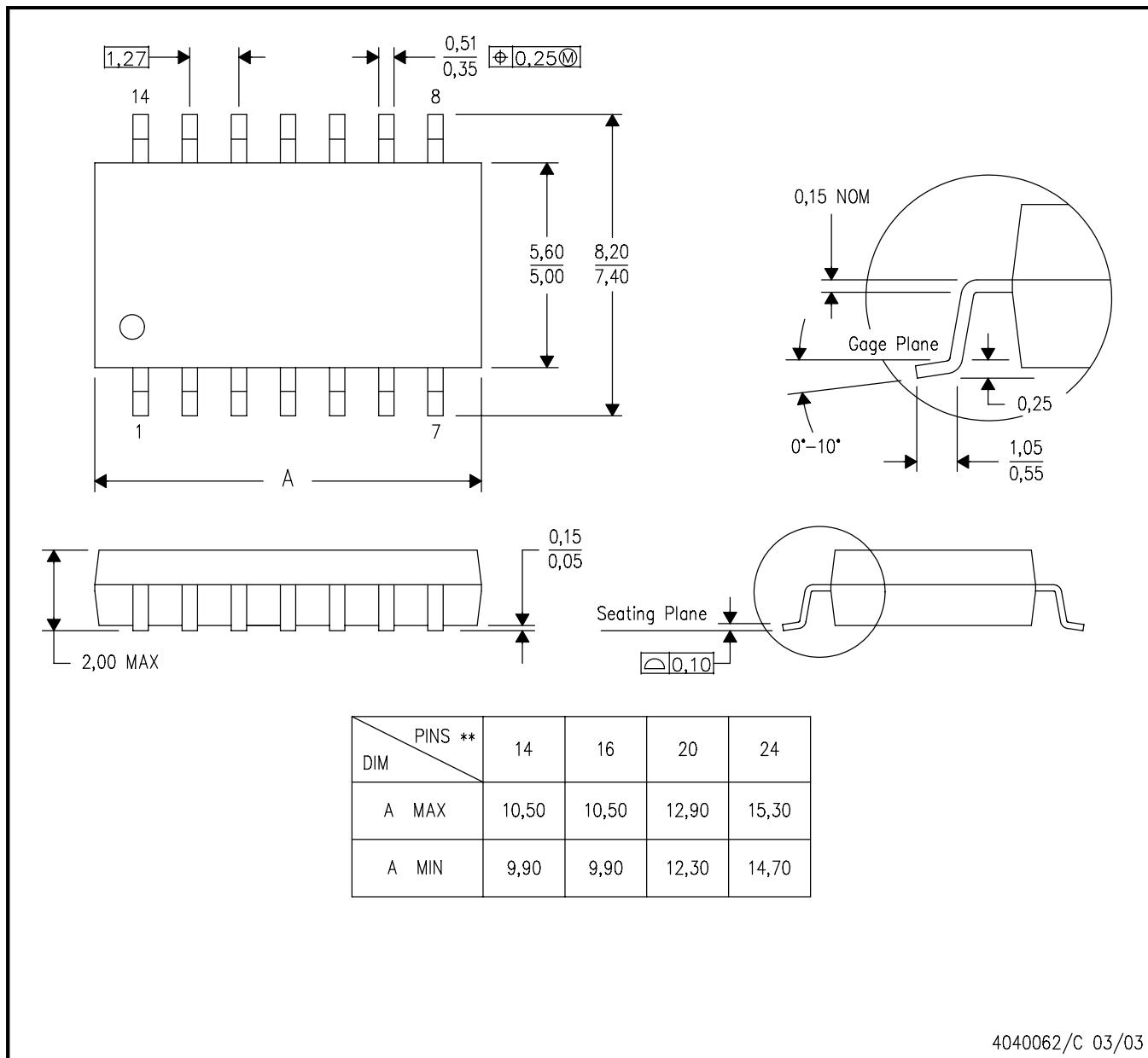
- NOTES: A. All linear dimensions are in inches (millimeters).
 B. This drawing is subject to change without notice.
 C. Body dimensions do not include mold flash or protrusion, not to exceed 0.006 (0.15).
 D. Falls within JEDEC MS-012

MECHANICAL DATA

NS (R-PDSO-G)**

14-PINS SHOWN

PLASTIC SMALL-OUTLINE PACKAGE



- NOTES: A. All linear dimensions are in millimeters.
 B. This drawing is subject to change without notice.
 C. Body dimensions do not include mold flash or protrusion, not to exceed 0,15.

4040062/C 03/03

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